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**General Information**

Series	SMD COTS X7R
Style	SMD Chip
Description	SMD, MLCC, COTS, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	false
Failure Rate	Testing per MIL-PRF-55681 PDA 8%, DPA per EIA-469, Humidity per MIL-STD-202, Method 103, Condition A
AEC-Q200	No
Typical Component Weight	16 mg
Shelf Life	78 Weeks
MSL	1

**Dimensions**

Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
T	1mm +/-0.10mm
S	0.7mm MIN
B	0.5mm +/-0.25mm

**Packaging Specifications**

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

**Specifications**

Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	10 GOhms

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